

20 V, 1.5 A low VF Schottky barrier rectifier

21 September 2023

Product data sheet

1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 1.5 A
- Reverse voltage: V_R ≤ 20 V
- Low forward voltage V_F ≤ 420 mV
- Low reverse current
- Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- LED backlight for mobile application
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

4. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Мах | Unit |
|--------------------|-------------------------|---|-----|-----|-----|-----|------|
| I _{F(AV)} | average forward current | δ < 0.5; f = 20 kHz; square wave; T _{amb} ≤ 100 °C | [1] | - | - | 1.5 | A |
| | | δ < 0.5; f = 20 kHz; square wave; T _{sp} ≤ 140 °C | | - | - | 1.5 | A |
| V _R | reverse voltage | T _j = 25 °C | | - | - | 20 | V |
| V _F | forward voltage | I _F = 1.5 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C | | - | 375 | 420 | mV |
| I _R | reverse current | V _R = 10 V; T _j = 25 °C | | - | 70 | 350 | μA |
| t _{rr} | reverse recovery time | $I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$ | | - | 5 | - | ns |

ne<mark>x</mark>peria

5. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--|-----------------------------------|
| 1 | К | cathode[1] | | |
| 2 | A | anode | | К Д А <i>sym001</i> |
| | | | Transparent top view DFN1608D-2 (SOD1608) | |

[1] The marking bar indicates the cathode.

6. Ordering information

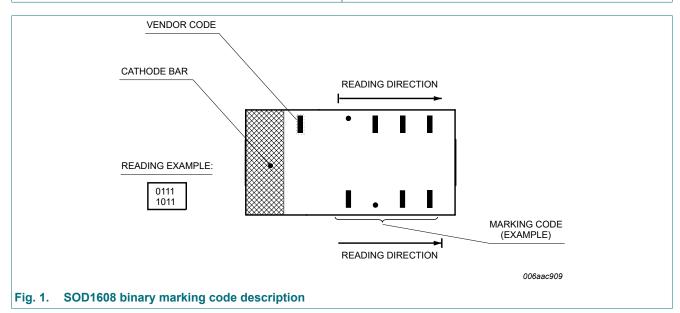
Table 3. Ordering information

| Type number | Package | | | | |
|---------------|------------|--|----------------|--|--|
| | Name | Description | Version | | |
| PMEG2015EPK-Q | DFN1608D-2 | plastic, leadless ultra small plastic package with side- wettable flanks (SWF); 2 terminals; 0.94 mm pitch; 1.6 mm x 0.8 mm x 0.37 mm body | <u>SOD1608</u> | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|---------------|--------------|
| PMEG2015EPK-Q | 1100 |
| | 0000 |



8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|--|---|---------|-----|------|------|
| V _R | reverse voltage | T _j = 25 °C | | - | 20 | V |
| l _F | forward current | T _{sp} ≤ 135 °C | | - | 2.1 | А |
| I _{F(AV)} | average forward current | δ < 0.5; f = 20 kHz; square wave; T _{amb} ≤ 100 °C | [1] | - | 1.5 | A |
| | | δ < 0.5; f = 20 kHz; square wave; T _{sp} ≤ 140 °C | | - | 1.5 | A |
| I _{FRM} | repetitive peak forward current | t _p = 1 ms; δ = 0.25 | | - | 4 | A |
| I _{FSM} | non-repetitive peak forward current | t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C | | - | 5 | A |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [2] [3] | - | 415 | mW |
| | | | [4] [3] | - | 895 | mW |
| | | | [1] [3] | - | 1565 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -55 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------|--|-------------|----------------|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] [2] [3] | - | - | 300 | K/W |
| | | | [1] [4] [3] | - | - | 140 | K/W |
| | | | [1] [5] [3] | - | - | 80 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [6] | - | - | 20 | K/W |

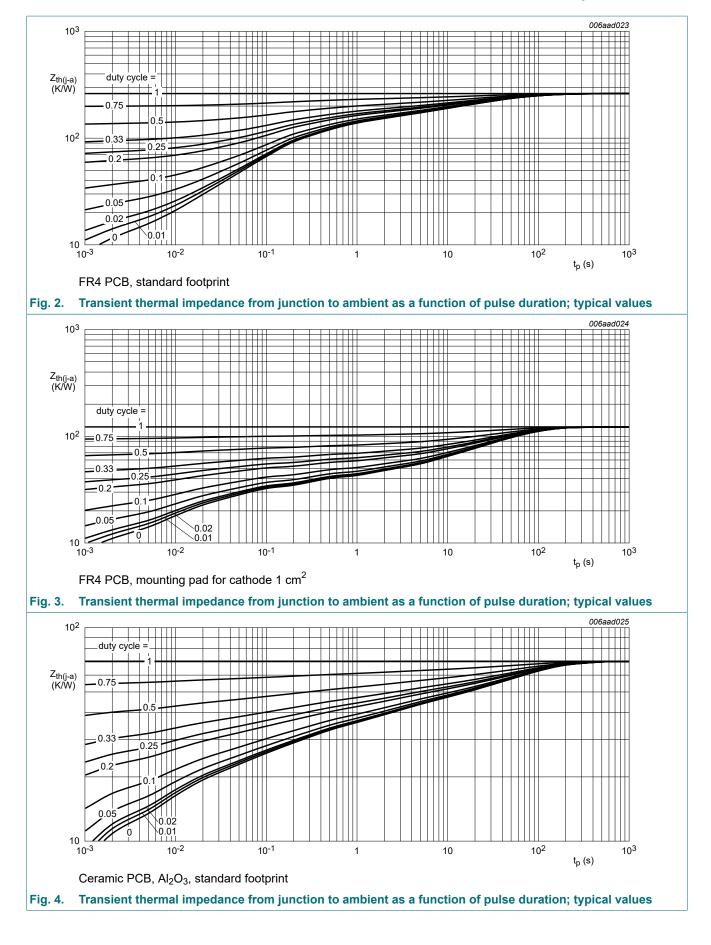
[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [5] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [6] Soldering point of cathode tab.

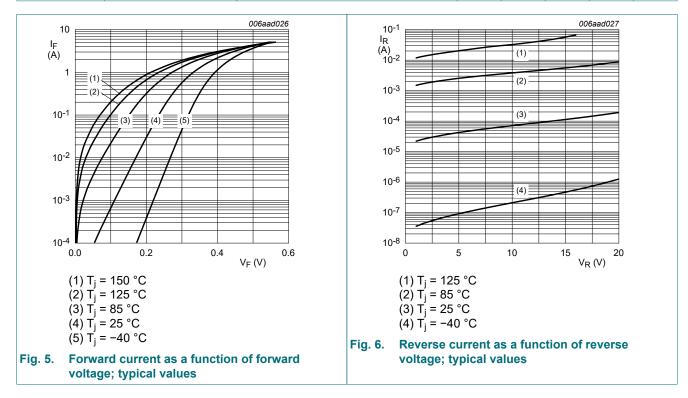
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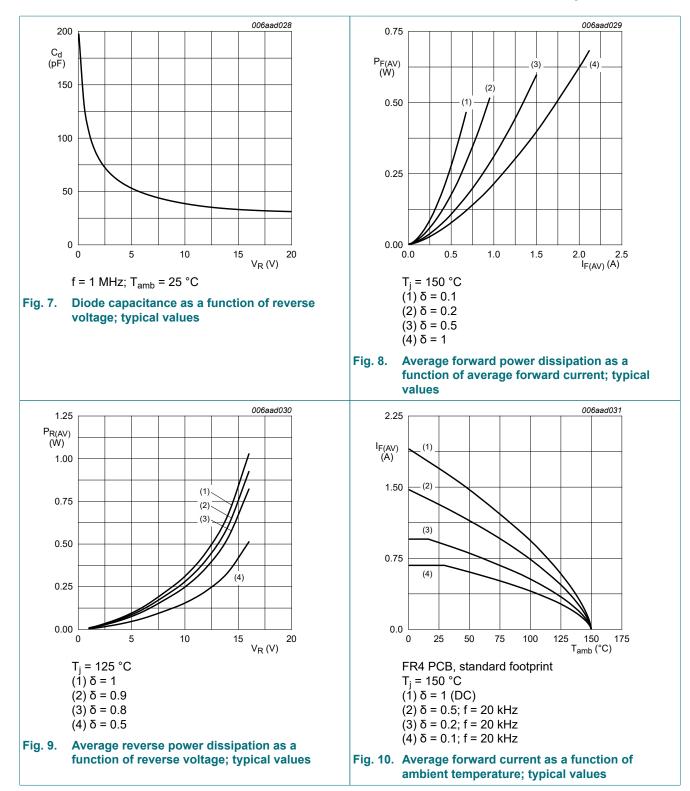
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10. Characteristics

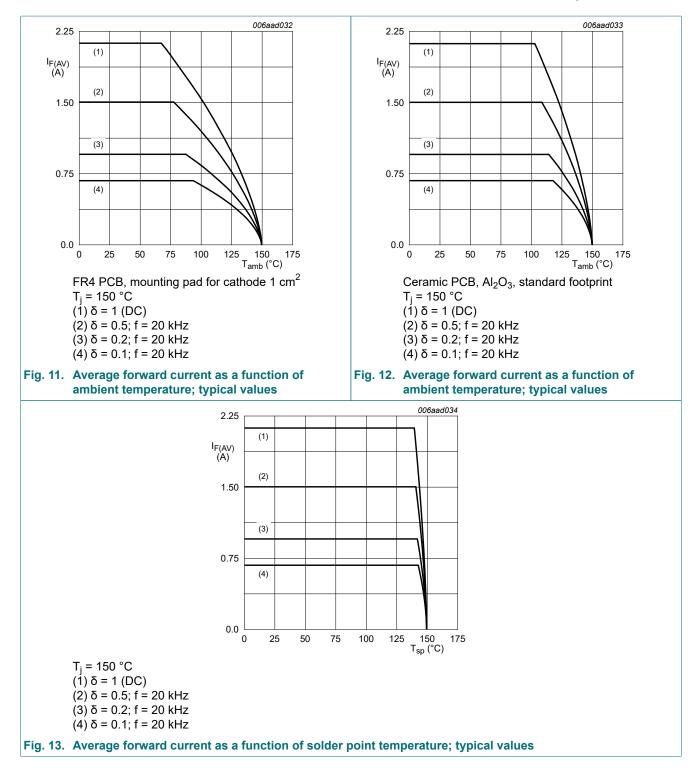
| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
|----------------------------------|-------------------------------|---|-----|-----|-----|------|
| VF | forward voltage | I _F = 100 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C | - | 230 | 260 | mV |
| | | I_F = 500 mA; pulsed; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C | - | 290 | 330 | mV |
| | | $\begin{array}{l} I_F = 1 \text{ A; pulsed; } t_p \leq \ 300 \ \mu\text{s; } \delta \leq \ 0.02\text{;} \\ T_j = 25 \ ^\circ\text{C} \end{array}$ | - | 330 | 380 | mV |
| | | I _F = 1.5 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C | - | 375 | 420 | mV |
| I _R reverse current | reverse current | V _R = 10 V; T _j = 25 °C | - | 70 | 350 | μA |
| | | V _R = 20 V; T _j = 25 °C | - | 220 | 900 | μA |
| C _d diode capacitance | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | - | 105 | 120 | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | - | 40 | 50 | pF |
| t _{rr} | reverse recovery time | $ I_F = 0.5 \text{ A}; \ I_R = 0.5 \text{ A}; \ I_{R(meas)} = 0.1 \text{ A}; \\ T_j = 25 \ ^\circ\text{C} $ | - | 5 | - | ns |
| V _{FRM} | peak forward recovery voltage | I _F = 0.5 A; dI _F /dt = 20 A/μs; T _j = 25 °C | - | 320 | - | mV |



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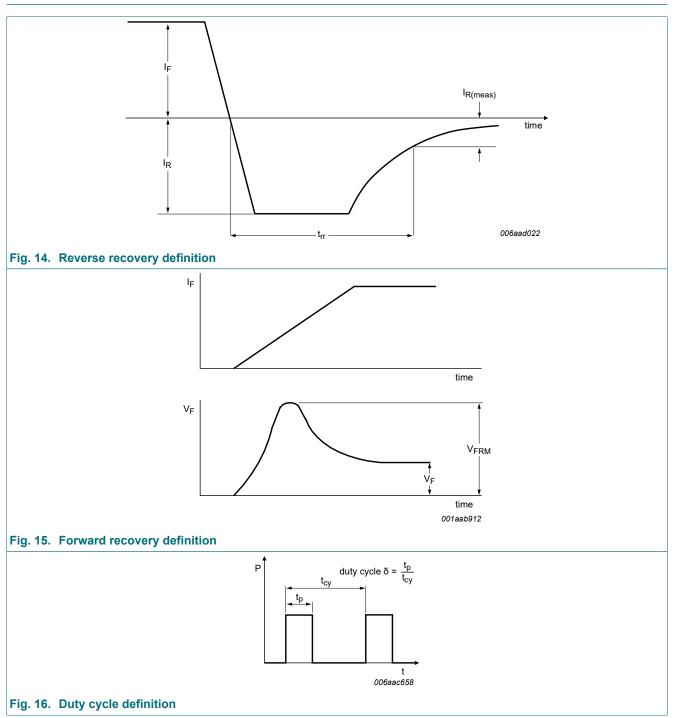
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11. Test information



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

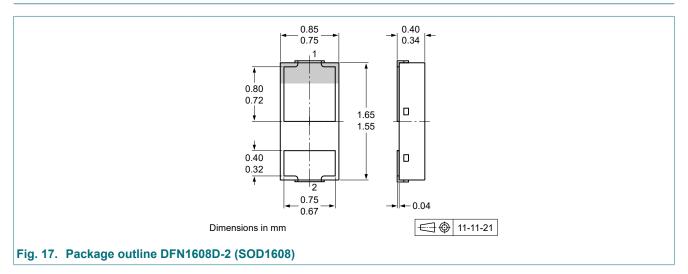
 $I_{RMS} = I_{F(AV)}$ at DC,

 $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

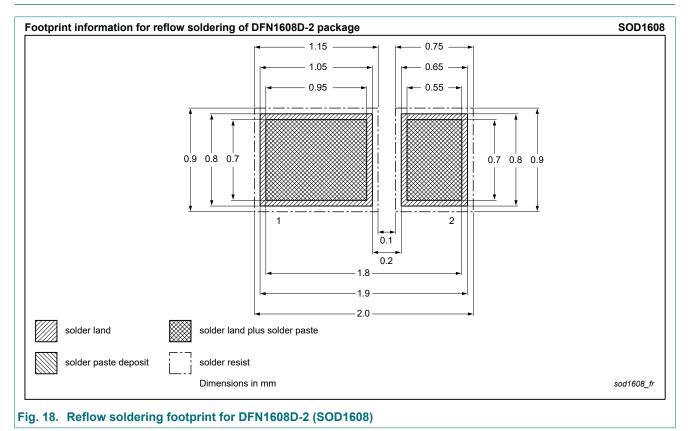
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

| Table 8. Revision history | | | | | | |
|---------------------------|--------------|--------------------|---------------|------------|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | |
| PMEG2015EPK-Q v.1 | 20230921 | Product data sheet | - | - | | |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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